

### **MOSFET**

## OptiMOS™ 6 Power-Transistor, 200 V

### **Features**

- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
   Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   Very low reverse recovery charge (Q<sub>rr</sub>)
- · High avalanche energy rating
- 175°C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- · 100% avalanche tested

### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

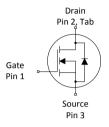
Table 1 Key performance parameters

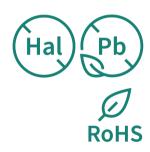
Parameter	Value	Unit
$V_{\mathrm{DS}}$	200	V
R <sub>DS(on),max</sub>	6.9	mΩ
$I_{D}$	136	А
$Q_{\rm oss}$	232	nC
$Q_{G}$	73	nC
Q <sub>rr</sub> (1000A/μs)	391	nC



PG-TO220-3







Part number	Package	Marking	Related links
IPP069N20NM6	PG-TO220-3	069N20N6	-

## Public

# OptiMOS™ 6 Power-Transistor, 200 V IPP069N20NM6



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# OptiMOS™ 6 Power-Transistor, 200 V IPP069N20NM6



# 1 Maximum ratings

at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			115.1	Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test condition
				136		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C
0 1)	,			96		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C
Continuous drain current 1)	l <sub>D</sub>	-	-	101	A	$V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C
				15.3		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =40°C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	544	Α	T <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	516	mJ	$I_{\rm D}$ =77 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	$V_{\rm GS}$	-20	-	20	V	-
Danier dissination	$P_{\mathrm{tot}}$	-	-	300	14/	<i>T</i> <sub>C</sub> =25 °C
Power dissipation				3.8	W	$T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>
Operating and storage temperature	$T_{\rm j}$ , $T_{\rm stg}$	-55	_	175	°C	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

## 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Syllibot	Min.	Тур.	Max.	Oille	Note / Test condition
Thermal resistance, junction - case	$R_{thJC}$		0.31	0.5		
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>5)</sup>	$R_{thJA}$	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	$R_{ m thJA}$		-	62		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 6 Power-Transistor, 200 V IPP069N20NM6



## 3 Electrical characteristics

at  $T_i$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			l lmit	Note / Test condition
Parameter	Syllibol	Min.	Тур.	Max.		Note / Test condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	200	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.7	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 258 \mu{\rm A}$
Zero gate voltage drain current	,	-	0.1	1		$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C
	I <sub>DSS</sub>		10	100	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance	D		5.9	6.9	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A
Diain-source on-state resistance	$R_{\rm DS(on)}$	-	5.2	6.3	111122	$V_{\rm GS}$ =15 V, $I_{\rm D}$ =100 A
Gate resistance	$R_{G}$	-	3.8	-	Ω	-
Transconductance <sup>6)</sup>	$g_{fs}$	33	65	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=100 \text{ A}$

<sup>6)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test condition
	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition
Input capacitance	C <sub>iss</sub>		5700	7400		
Output capacitance <sup>7)</sup>	$C_{\rm oss}$	-	910	1200	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =100 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>7)</sup>	C <sub>rss</sub>		30	52		
Turn-on delay time	$t_{d(on)}$		17			
Rise time	t <sub>r</sub>		56		ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{\sf d(off)}$		37	]		
Fall time	t <sub>f</sub>		29			

<sup>&</sup>lt;sup>7)</sup> Defined by design. Not subject to production test.

# OptiMOS™ 6 Power-Transistor, 200 V IPP069N20NM6



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Linit	Note / Test condition
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Gate to source charge	$Q_{\mathrm{gs}}$		38	-	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	21 - nC				
Gate to drain charge <sup>9)</sup>	$Q_{\mathrm{gd}}$		14	21	nC	 
Switching charge	$Q_{sw}$	31 - nC V <sub>DD</sub> -100 V, I <sub>L</sub>	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V			
Gate charge total <sup>9)</sup>	$Q_{\rm g}$					
Gate plateau voltage	$V_{ m plateau}$		6.6	-	V	
Gate charge total, sync. FET	$Q_{\rm g(sync)}$	-	63	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V
Output charge <sup>9)</sup>	Q <sub>oss</sub>	-	232	302	nC	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V

 $<sup>^{8)}~~{\</sup>rm See}$  "Gate charge waveforms" for parameter definition

### Table 7 Reverse diode

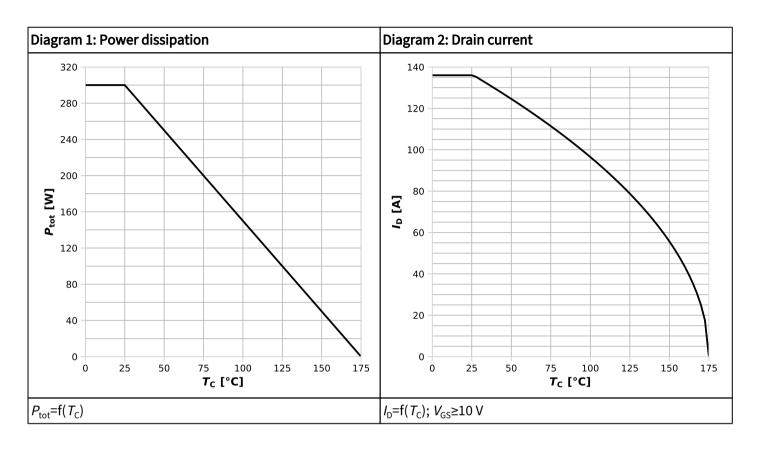
Parameter	Symbol	Values			Linit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.		Note / Test condition	
Diode continuous forward current	Is			136	A	<i>T<sub>c</sub></i> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>		_	544	_ A	1 <sub>C</sub> -23 C	
Diode forward voltage	$V_{\rm SD}$	-	0.92	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =100 A, $T_{\rm j}$ =25 °C	
Reverse recovery time <sup>10)</sup>	$t_{\rm rr}$		53	-	ns	$V_{\rm p}$ =100 V, $I_{\rm f}$ =50 A, d $i_{\rm f}$ /d $t$ =100 A/ $\mu$ s	
Reverse recovery charge <sup>10)</sup>	$Q_{rr}$		70	140	nC	ν <sub>R</sub> -100 ν, ι <sub>F</sub> -30 Α, αι <sub>F</sub> /αι-100 Α/ μs	
Reverse recovery time <sup>10)</sup>	$t_{\rm rr}$		38	-	ns	1/-100 \	
Reverse recovery charge <sup>10)</sup>	$Q_{rr}$	]-	391	391 782	nC	$V_{\rm R}$ =100 V, $I_{\rm F}$ =50 A, d $I_{\rm F}$ /d $t$ =1000 A/ $\mu$ s	

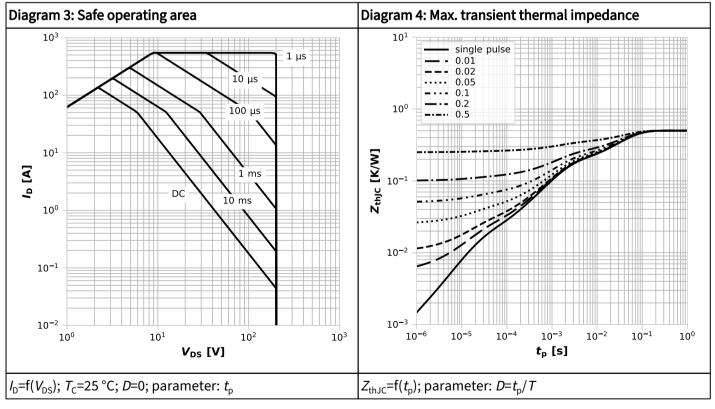
 $<sup>^{10)}\,\,</sup>$  Defined by design. Not subject to production test.

<sup>9)</sup> Defined by design. Not subject to production test.

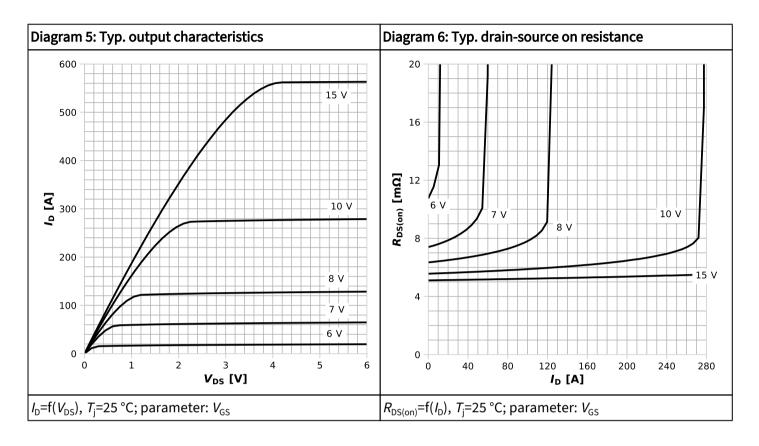


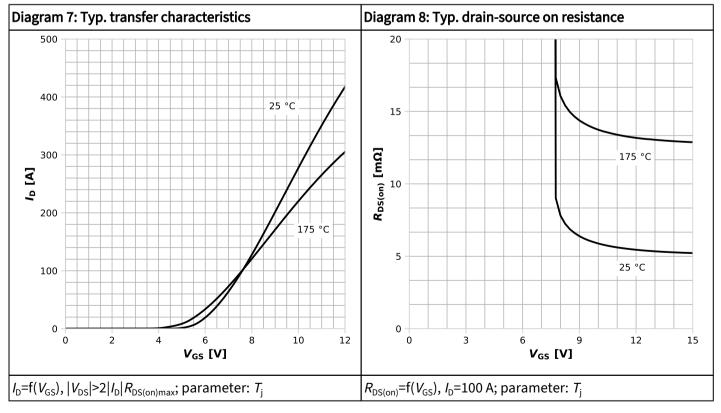
# 4 Electrical characteristics diagrams



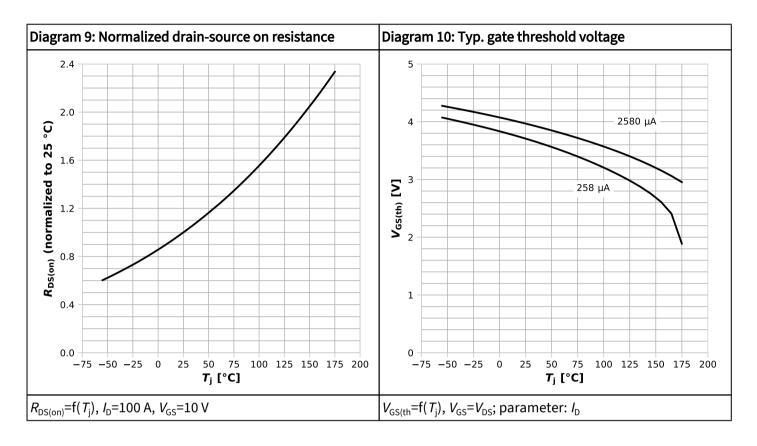


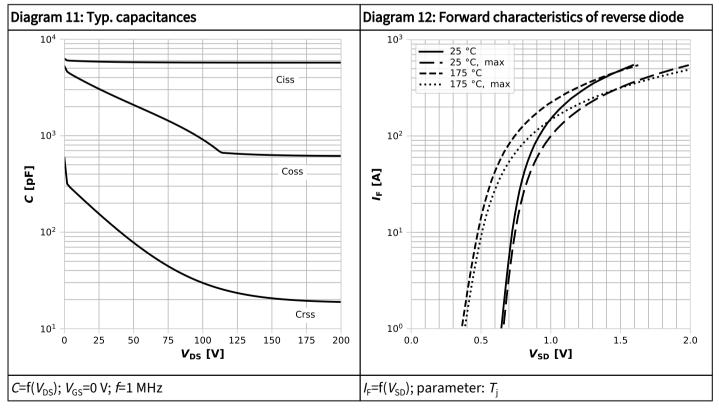




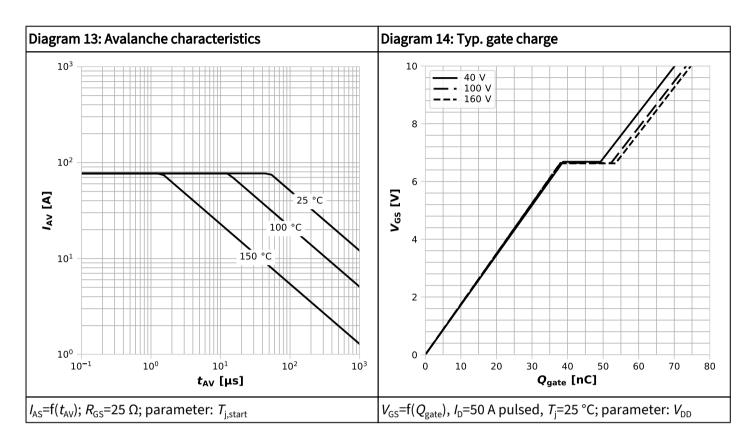


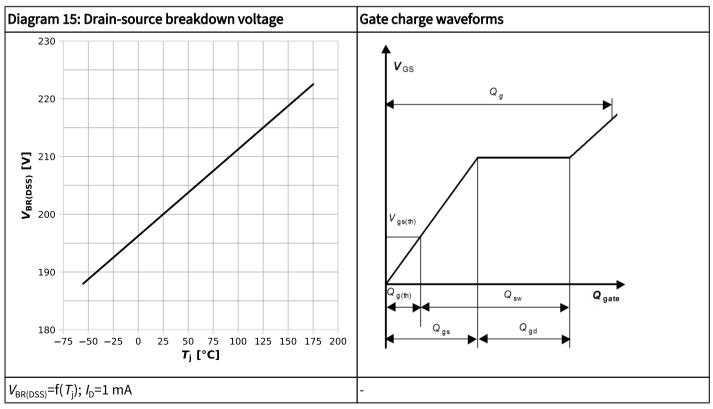














# 5 Package outlines

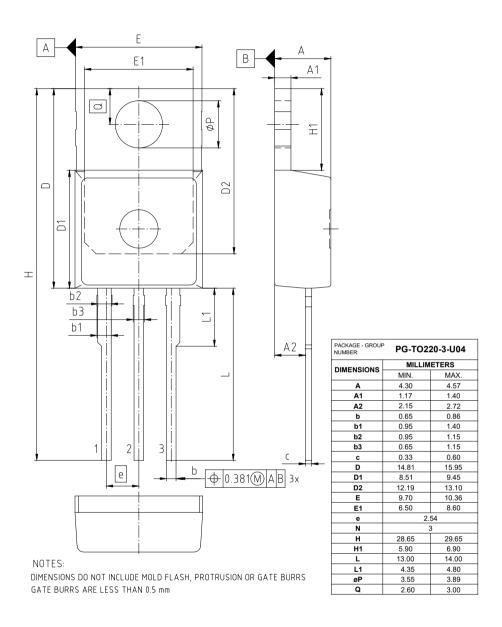


Figure 1 Outline PG-TO220-3, dimensions in mm

## Public

# OptiMOS™ 6 Power-Transistor, 200 V IPP069N20NM6



## **Revision history**

IPP069N20NM6

## Revision 2025-02-26, Rev. 2.1

Previous revisions

Revision	Date	Subjects (major changes since last revision)
2.0	2023-12-07	Release of final version
2.1	2025-02-26	Update "Features"

#### Public

# OptiMOS™ 6 Power-Transistor, 200 V IPP069N20NM6



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